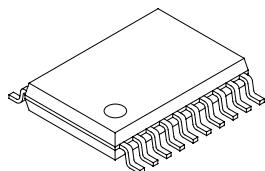


## 6-channel CCD Vertical Clock Driver

### Description

The CXD3400N is a vertical clock driver for CCD image sensor. This IC is composed of 6 channels which supports high frame rate readout mode.

20 pin SSOP (Plastic)



### Features

- Composition
  - Vertical transfer output 3 levels driver × 4
  - 2 levels driver × 2
- Electronic shutter output 2 levels driver × 1
- Suitable drive capability for high-pixel CCD  
(40% improved compared to current device)
- Small package (20-pin SSOP)
- 2.7 to 5.5V supported input interface

### Applications

Digital still camera

### Structure

CMOS

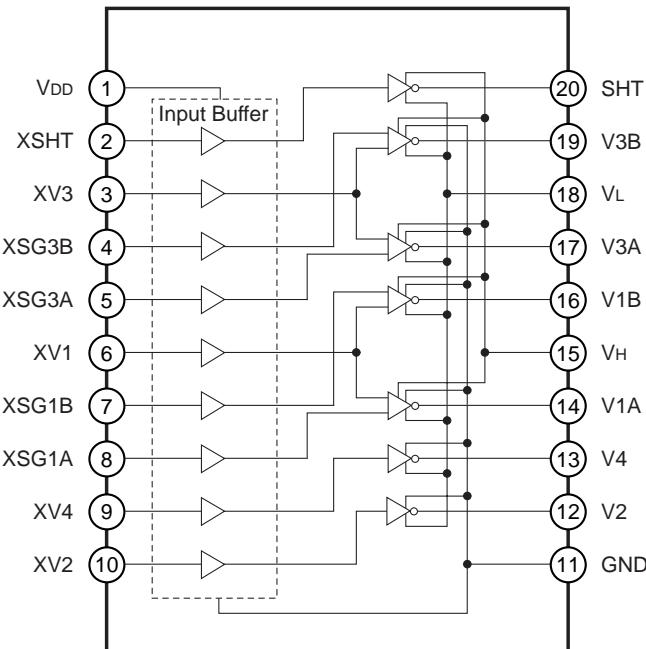
### Absolute Maximum Ratings

• Supply voltage	V <sub>DD</sub>	GND – 0.3 to +7.0	V
• Supply voltage	V <sub>L</sub>	GND to –10	V
• Supply voltage	V <sub>H</sub>	V <sub>L</sub> + 26	V
• Input voltage	V <sub>IN</sub>	GND – 0.3V to V <sub>DD</sub> + 0.3	V
• Operating temperature	T <sub>Op</sub>	–20 to +75	°C
• Storage temperature	T <sub>Stg</sub>	–55 to +150	°C

### Recommended Operating Conditions

• Supply voltage	V <sub>DD</sub>	2.7 to 5.5	V
• Supply voltage	V <sub>L</sub>	–5.0 to –9.0	V
• Supply voltage	V <sub>H</sub>	11.5 to 15.5	V
• Operating temperature	T <sub>Op</sub>	–20 to +75	°C

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**Block Diagram****Pin Description**

Pin No.	Symbol	I/O	Functions
1	V <sub>DD</sub>	—	Input power supply (3.3V system)
2	XSHT	I	SHT pulse input
3	XV3	I	V3A and V3B transfer pulse input
4	XSG3B	I	V3B readout pulse input
5	XSG3A	I	V3A readout pulse input
6	XV1	I	V1A and V1B readout pulse input
7	XSG1B	I	V1B readout pulse input
8	XSG1A	I	V1A readout pulse input
9	XV4	I	V4 transfer pulse input
10	XV2	I	V2 transfer pulse input
11	GND	—	GND (= V <sub>M</sub> )
12	V2	O	High voltage output (2 levels: V <sub>H</sub> , V <sub>L</sub> )
13	V4	O	High voltage output (2 levels: V <sub>H</sub> , V <sub>L</sub> )
14	V1A	O	High voltage output (3 levels: V <sub>H</sub> , V <sub>M</sub> , V <sub>L</sub> )
15	V <sub>H</sub>	—	Positive power supply for high voltage output (15V system)
16	V1B	O	High voltage output (3 levels: V <sub>H</sub> , V <sub>M</sub> , V <sub>L</sub> )
17	V3A	O	High voltage output (3 levels: V <sub>H</sub> , V <sub>M</sub> , V <sub>L</sub> )
18	V <sub>L</sub>	—	Negative power supply for high voltage output (-7.5V system)
19	V3B	O	High voltage output (3 levels: V <sub>H</sub> , V <sub>M</sub> , V <sub>L</sub> )
20	SHT	O	High voltage output (2 levels: V <sub>H</sub> , V <sub>L</sub> )

**Truth Table**

Input				Output		
XV1, 3	XSG1A, 1B, 3A, 3B	XV2, 4	XSHT	V1A, 1B, 3A, 3B	V2, 4	SHT
L	L	X	X	V <sub>H</sub>	X	X
L	H	X	X	V <sub>M</sub>	X	X
H	L	X	X	Z	X	X
H	H	X	X	V <sub>L</sub>	X	X
X	X	L	X	X	V <sub>M</sub>	X
X	X	H	X	X	V <sub>L</sub>	X
X	X	X	L	X	X	V <sub>H</sub>
X	X	X	H	X	X	V <sub>L</sub>

Z: High impedance X: Don't care

**Electrical Characteristics****DC Characteristics**(V<sub>DD</sub> = 3.3V, V<sub>H</sub> = 15V, V<sub>M</sub> = GND, V<sub>L</sub> = -8.5V)

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
"H" level input voltage	V <sub>IH</sub>		0.7V <sub>DD</sub>	—	—	V
"L" level input voltage	V <sub>IL</sub>		—	—	0.3V <sub>DD</sub>	V
Input current	I <sub>IN</sub>	V <sub>IN</sub> = GND to 5V	-10	0.0	10	µA
Operating supply current	I <sub>H</sub>	*1	—	0.10	0.20	mA
Operating supply current	I <sub>DD</sub>	*1	—	0.25	0.50	mA
Operating supply current	I <sub>L</sub>	*1	-8.5	-5.5	—	mA
Output current	I <sub>OL</sub>	V1A, 1B, 3A, 3B, V2, 4 = -8.25V	10	—	—	mA
Output current	I <sub>OM1</sub>	V1A, 1B, 3A, 3B, V2, 4 = -0.25V	—	—	-5.0	mA
Output current	I <sub>OM2</sub>	V1A, 1B, 3A, 3B = 0.25V	5.0	—	—	mA
Output current	I <sub>OH</sub>	V1A, 1B, 3A, 3B = 14.75V	—	—	-7.2	mA
Output current	I <sub>OSL</sub>	SHT = -8.25V	5.4	—	—	mA
Output current	I <sub>OSS</sub>	SHT = 14.75V	—	—	-4.0	mA

\*1 See Measurement Circuit. Shutter speed 1/10000

**Note)** Current direction +: inflow to IC; -: outflow from IC

**Switching Characteristics**(V<sub>DD</sub> = 3.3V, V<sub>H</sub> = 15V, V<sub>M</sub> = GND, V<sub>L</sub> = -7.5V)

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Propagation delay time	T <sub>PLM</sub>	*1	50	70	100	ns
Propagation delay time	T <sub>PMH</sub>	*1	50	70	100	ns
Propagation delay time	T <sub>PLH</sub>	*1	50	70	100	ns
Propagation delay time	T <sub>PMI</sub>	*1	10	30	50	ns
Propagation delay time	T <sub>PHM</sub>	*1	10	30	50	ns
Propagation delay time	T <sub>PHL</sub>	*1	10	30	50	ns
Rise time	T <sub>TLM</sub>	V <sub>L</sub> → V <sub>M</sub> *1	200	350	500	ns
Rise time	T <sub>TMH</sub>	V <sub>M</sub> → V <sub>H</sub> *1	200	350	500	ns
Rise time	T <sub>TLH</sub>	V <sub>L</sub> → V <sub>H</sub> *1	30	60	90	ns
Fall time	T <sub>TML</sub>	V <sub>M</sub> → V <sub>L</sub> *1	200	350	500	ns
Fall time	T <sub>THM</sub>	V <sub>H</sub> → V <sub>M</sub> *1	200	350	500	ns
Fall time	T <sub>THL</sub>	V <sub>H</sub> → V <sub>L</sub> *1	30	60	90	ns
Output noise voltage	V <sub>C LH</sub>	*2	—	—	1.0	V
Output noise voltage	V <sub>C LL</sub>	*2	—	—	1.0	V
Output noise voltage	V <sub>C MH</sub>	*2	—	—	1.0	V
Output noise voltage	V <sub>C ML</sub>	*2	—	—	1.0	V

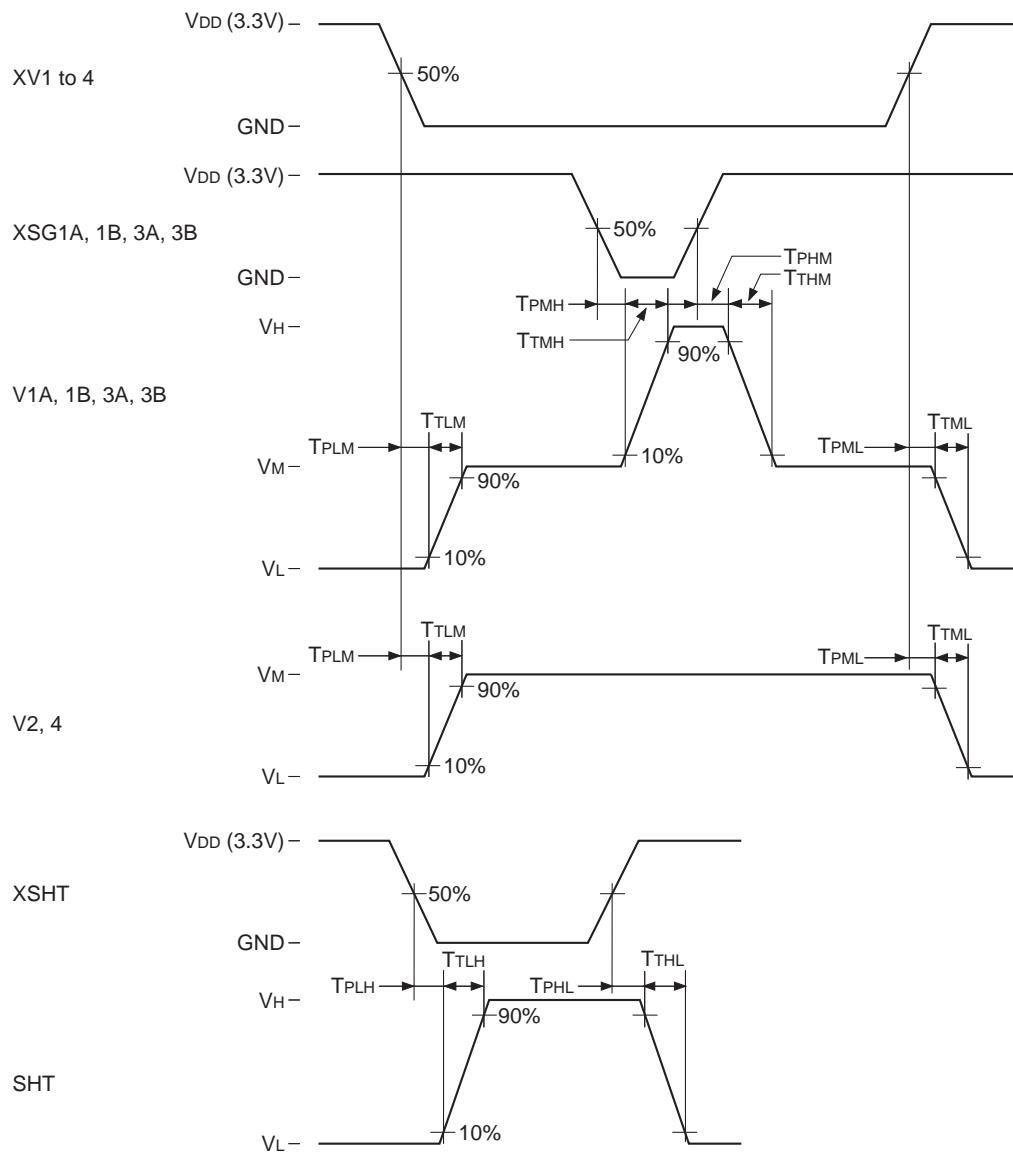
\*1 See Switching Waveform.

\*2 See Noise on a Waveform.

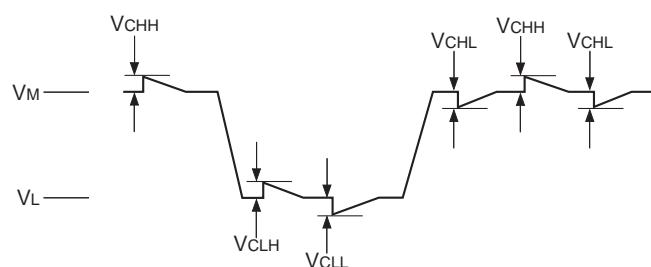
**Note)** Each item is evaluated by Measurement Circuit.**Notes on Operation** (See Application Circuit.)

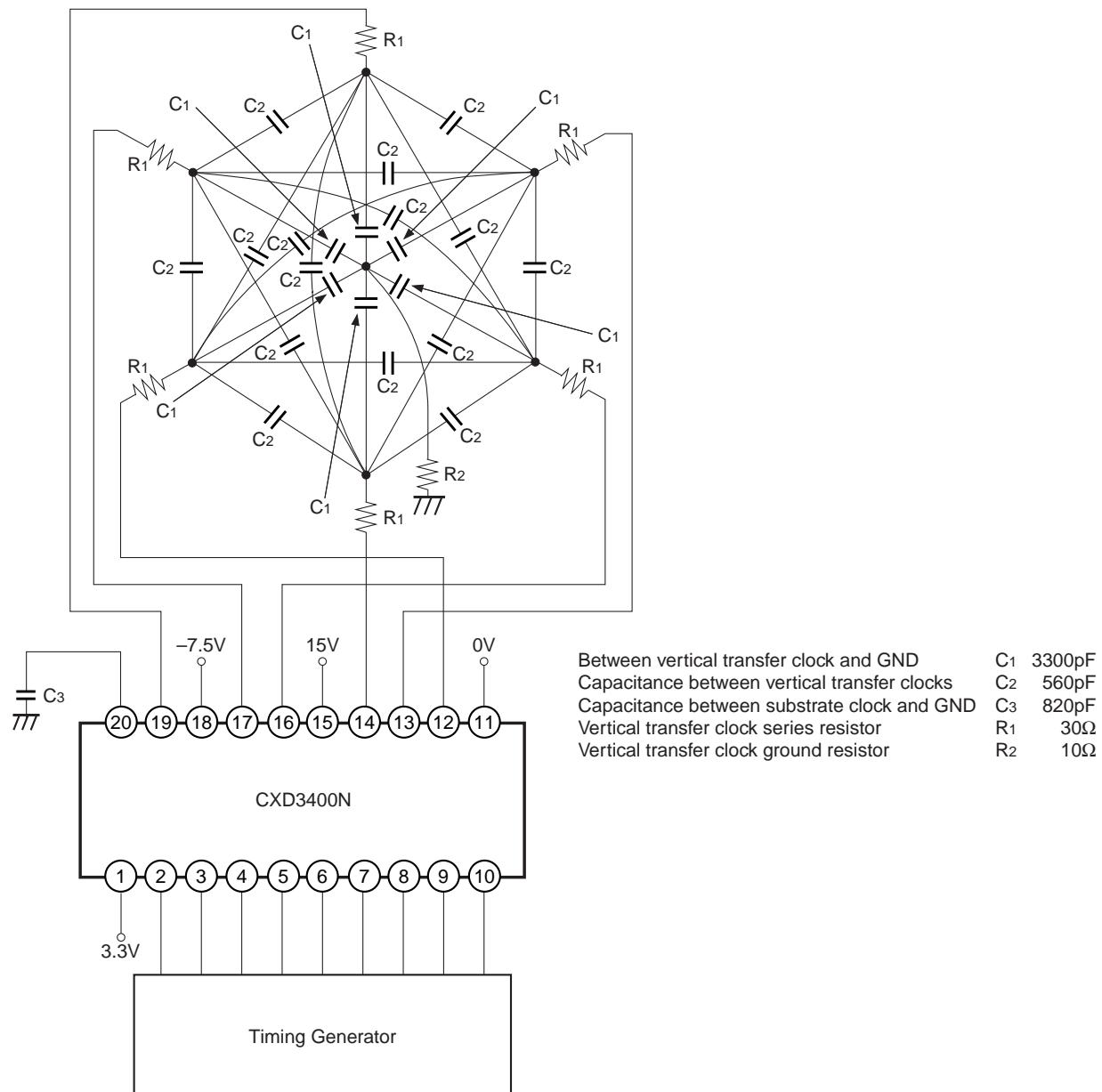
1. Be sure to protect against static electricity because this IC is MOS structure.
2. A bypass capacitor (0.1μF or more) is connected between GND and near each power supply (V<sub>H</sub>, V<sub>DD</sub>, V<sub>L</sub>).
3. In order to protect CCD image sensor, input SHT pin output to SUB pin of CCD image sensor after that has been clamped at V<sub>H</sub>.

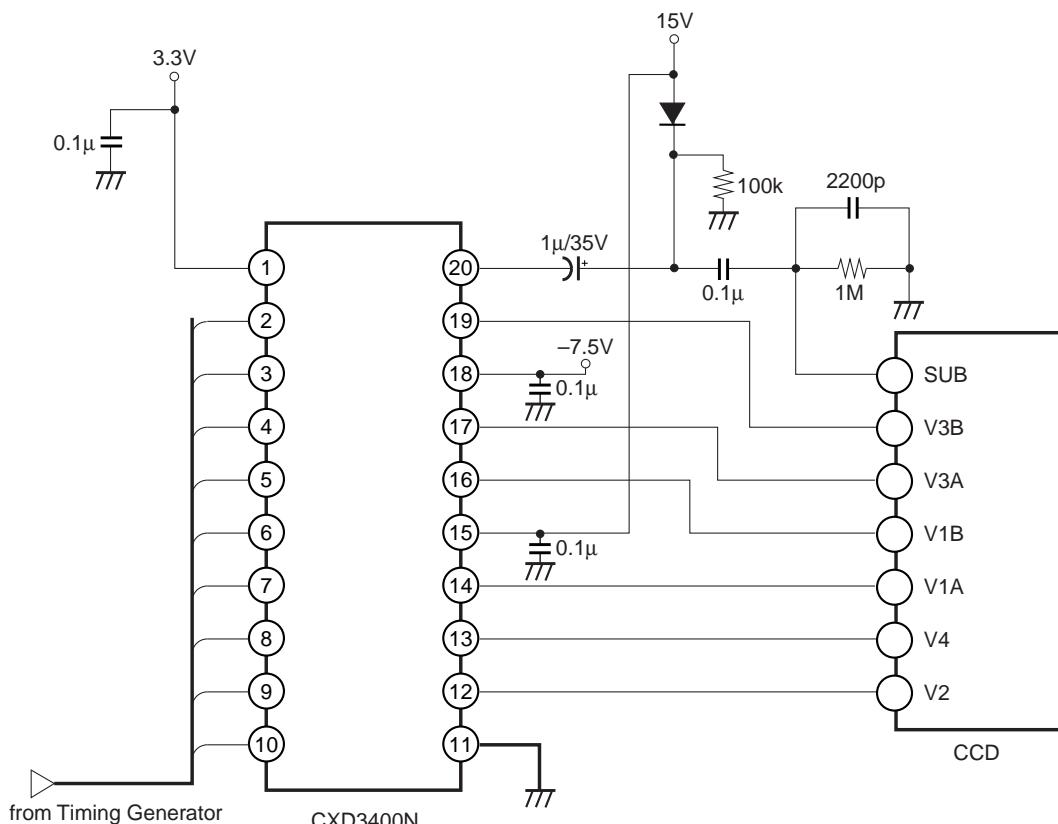
### Switching Waveform



### Noise on a Waveform



**Measurement Circuit**

**Application Circuit**

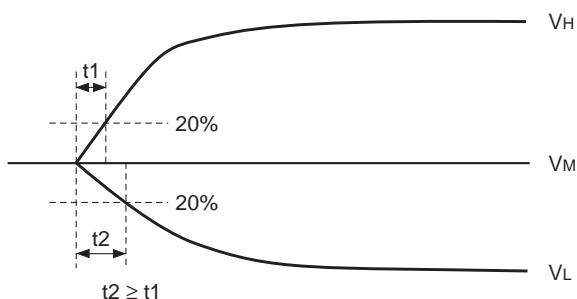
\* See with drive circuit of CCD image sensor.

Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party patent and other right due to same.

**Note with Power-on Sequence**

To protect CCD image sensor, rise two power supplies,  $V_L$  and  $V_H$  as follows.

Note that rise  $V_{DD}$  first.



## Package Outline

Unit: mm

